

a conducting film layer formed on said base film, and
an adhesion layer formed on said conducting film layer,
wherein said adhesion layer is between said conducting film
layer and a cover film.

2. (amended) A transfer film comprising:

*Cl
amp.*
a base film,
a heat absorption film layer formed on said base film,
a conducting film layer formed on said heat absorption film
layer, and
an adhesion layer formed on said conducting film layer,
wherein said adhesion layer is between said conducting film
layer and a cover film.
